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# P1K0.0805.1FC.B

# FlipChip platinum sensor

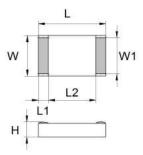
## For the automatic assembling on PCB by soldering or bonding

## Benefits & Characteristics

- Excellent long-term stability
- Low self-heating
- Fast response time

- Minimum space consumption on PCB
- Optimal price-performance ratio

## Illustration<sup>1)</sup>



## Technical Data

Operating temperature range:	-50 °C to +150 °C
Nominal resistance:	1000 Ω at 0 °C
Characteristics curve:	3850 ppm/K
Long-term stability:	< 0.04 % at 1000 h at 130 °C
Tolerance class (dependent on temperature range):	IEC 60751 F0.3 B (IST AG reference)
Connection:	tin-coated, LMP lead-free, 96.5Sn/3Ag/0.5Cu) (reflow soldering)
Dimensions:	1.9 / 0.25 / 1.4 x 1.15 / 1.1 x 0.45
Tolerance:	±0.2 mm (H ±0.15)
Solderability:	235 °C ≤ 8 s (DIN IEC 68 T2-20, Ta Meth. 1)
Resistance to soldering heat: 1)  1) The soldering process can influence accuracy	260 °C 10 s (DIN IEC 68 T2-20, Ta Meth. 1A)
Recommended applied current: <sup>2)</sup> 2) Self-heating must be considered	0.3 mA at 1000 $\Omega$
Packaging:	< 100 pcs in trays

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## **Product Photo**



### Order Information

Description: Item number: Former main reference: P1K0.0805.1FC.B 101130 010.02557

#### Additional Documents

Document name: Application Note: ATP\_E



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